

SCES630B-JULY 2005-REVISED AUGUST 2005

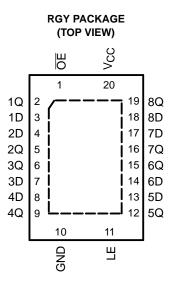
#### FEATURES

- Inputs Are TTL-Voltage Compatible
- 4.5-V to 5.5-V V<sub>cc</sub> Operation
- Typical t<sub>pd</sub> of 5.1 ns at 5 V
- Typical  $V_{OLP}$  (Output Ground Bounce) <0.8 V at  $V_{CC}$  = 5 V,  $T_A$  = 25°C
- Typical V<sub>OHV</sub> (Output V<sub>OH</sub> Undershoot)
   >2.3 V at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C
- Supports Mixed-Mode Voltage Operation on All Ports

|             | (TOP VIEW) |   |    |      |  |  |  |  |  |  |  |  |
|-------------|------------|---|----|------|--|--|--|--|--|--|--|--|
| <u>oe</u> [ | 1          | υ | 20 | Vcc  |  |  |  |  |  |  |  |  |
| 1Q [        | 2          |   | 19 | ] 8Q |  |  |  |  |  |  |  |  |
| 1D [        | 3          |   | 18 | 8D   |  |  |  |  |  |  |  |  |
| 2D [        | 4          |   | 17 | ] 7D |  |  |  |  |  |  |  |  |
| 2Q [        | 5          |   | 16 | ] 7Q |  |  |  |  |  |  |  |  |
| 3Q [        | 6          |   | 15 | ] 6Q |  |  |  |  |  |  |  |  |
| 3D [        | 7          |   | 14 | 6D   |  |  |  |  |  |  |  |  |
| 4D [        | 8          |   | 13 | 5D   |  |  |  |  |  |  |  |  |
| 4Q [        | 9          |   | 12 | 5Q   |  |  |  |  |  |  |  |  |
| GND         | 10         |   | 11 | LE   |  |  |  |  |  |  |  |  |

DB, DW, NS, OR PW PACKAGE

- I<sub>off</sub> Supports Partial-Power-Down Mode Operation
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- ESD Protection Exceeds JESD 22
  - 2000-V Human-Body Model (A114-A)
  - 200-V Machine Model (A115-A)
  - 1000-V Charged-Device Model (C101)



### **DESCRIPTION/ORDERING INFORMATION**

The SN74LV373AT is an octal transparent D-type latch. While the latch-enable (LE) input is high, the Q outputs follow the data (D) inputs. When LE is taken low, the Q outputs are latched at the logic levels set up at the D inputs.

| T <sub>A</sub> | PAC        | KAGE <sup>(1)</sup> | ORDERABLE PART NUMBER       | TOP-SIDE MARKING |  |
|----------------|------------|---------------------|-----------------------------|------------------|--|
|                | QFN – RGY  | Reel of 1000        | SN74LV373ATRGYR             | VV373            |  |
|                | SOIC - DW  | Tube of 25          | SN74LV373ATDW               | LV373AT          |  |
|                | 50IC - DW  | Reel of 2500        | Reel of 2500 SN74LV373ATDWR |                  |  |
| 40°C to 125°C  | SOP – NS   | Reel of 2000        | SN74LV373ATNSR              | 74LV373AT        |  |
| –40°C to 125°C | SSOP – DB  | Reel of 2000        | SN74LV373ATDBR              | LV373AT          |  |
|                |            | Tube of 70          | SN74LV373ATPW               |                  |  |
|                | TSSOP – PW | Reel of 2000        | SN74LV373ATPWR              | LV373AT          |  |
|                |            | Reel of 250         | SN74LV373ATPWT              |                  |  |

(1) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



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### SN74LV373AT **OCTAL TRANSPARENT D-TYPE LATCH** WITH 3-STATE OUTPUTS

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### **DESCRIPTION/ORDERING INFORMATION (CONTINUED)**

A buffered output-enable (OE) input can be used to place the eight outputs in either a normal logic state (high or low) or the high-impedance state. In the high-impedance state, the outputs neither load nor drive the bus lines significantly. The high-impedance state and increased drive provide the capability to drive bus lines without need for interface or pullup components.

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OE does not affect the internal operations of the latches. Old data can be retained or new data can be entered while the outputs are in the high-impedance state.

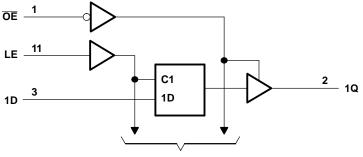
To ensure the high-impedance state during power up or power down,  $\overline{OE}$  should be tied to V<sub>CC</sub> through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

This device is fully specified for partial-power-down applications using I<sub>off</sub>. The I<sub>off</sub> circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

| (EACH LATCH) |        |   |                |  |  |  |  |  |  |  |
|--------------|--------|---|----------------|--|--|--|--|--|--|--|
|              | OUTPUT |   |                |  |  |  |  |  |  |  |
| OE           | LE     | D | Q              |  |  |  |  |  |  |  |
| I            | Н      | Н | Н              |  |  |  |  |  |  |  |
| L            | Н      | L | L              |  |  |  |  |  |  |  |
| L            | L      | Х | Q <sub>0</sub> |  |  |  |  |  |  |  |
| Н            | Х      | Х | Z              |  |  |  |  |  |  |  |

# FUNCTION TABLE

#### LOGIC DIAGRAM (POSITIVE LOGIC)



**To Seven Other Channels** 

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# Absolute Maximum Ratings<sup>(1)</sup>

over operating free-air temperature range (unless otherwise noted)

|                  |  |  | MIN  | MAX                   | UNIT |  |
|------------------|--|--|------|-----------------------|------|--|
| V <sub>CC</sub>  | Supply voltage range                       |  | -0.5 | 7                     | V    |  |
| VI               | Input voltage range <sup>(2)</sup>         |  | -0.5 | 7                     | V    |  |
| Vo               | Voltage range applied to any output in th  | e high-impedance or power-off state <sup>(2)</sup> | -0.5 | 7                     | V    |  |
| Vo               | Output voltage range <sup>(2)(3)</sup>     |  | -0.5 | V <sub>CC</sub> + 0.5 | V    |  |
| I <sub>IK</sub>  | Input clamp current                        | V <sub>1</sub> < 0                                 |      | -20                   | mA   |  |
| I <sub>OK</sub>  | Output clamp current                       | $V_{O} < 0 \text{ or } V_{O} > V_{CC}$             |      | ±50                   | mA   |  |
| I <sub>O</sub>   | Continuous output current                  | $V_{O} = 0$ to $V_{CC}$                            |      | ±35                   | mA   |  |
|                  | Continuous current through $V_{CC}$ or GND | Continuous current through V <sub>CC</sub> or GND  |      |                       |      |  |
|                  |  | DB package <sup>(4)</sup>                          |      | 70                    |      |  |
|                  |  | DW package <sup>(4)</sup>                          |      | 58                    |      |  |
| $\theta_{JA}$    | Package thermal impedance                  | NS package <sup>(4)</sup>                          |      | 60                    | °C/W |  |
|                  |  | PW package <sup>(4)</sup>                          |      | 83                    |      |  |
|                  |  | RGY package <sup>(5)</sup>                         |      | 37                    |      |  |
| T <sub>stg</sub> | Storage temperature range                  |  | -65  | 150                   | °C   |  |

(1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed.

(3) This value is limited to 5.5 V maximum.

(4) The package thermal impedance is calculated in accordance with JESD 51-7.

(5) The package thermal impedance is calculated in accordance with JESD 51-5.

#### **Recommended Operating Conditions**<sup>(1)</sup>

|                     |                                    |  | MIN | MAX             | UNIT |
|---------------------|------------------------------------|--|-----|-----------------|------|
| V <sub>CC</sub>     | Supply voltage                     |  | 4.5 | 5.5             | V    |
| V <sub>IH</sub>     | High-level input voltage           | $V_{CC}$ = 4.5 V to 5.5 V                          | 2   |                 | V    |
| V <sub>IL</sub>     | Low-level input voltage            | $V_{CC}$ = 4.5 V to 5.5 V                          |     | 0.8             | V    |
| VI                  | Input voltage                      |  | 0   | 5.5             | V    |
|                     | Output voltogo                     | High or low state                                  | 0   | V <sub>CC</sub> | V    |
| Vo                  | Output voltage                     | 3-state  | 0   | 5.5             | v    |
| I <sub>OH</sub>     | High-level output current          | $V_{CC}$ = 4.5 V to 5.5 V                          |     | -16             | mA   |
| I <sub>OL</sub>     | Low-level output current           | $V_{CC}$ = 4.5 V to 5.5 V                          |     | 16              | mA   |
| $\Delta t/\Delta v$ | Input transition rise or fall rate | $V_{CC} = 4.5 \text{ V} \text{ to } 5.5 \text{ V}$ |     | 20              | ns/V |
| T <sub>A</sub>      | Operating free-air temperature     |  | -40 | 125             | °C   |

 All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

# SN74LV373AT OCTAL TRANSPARENT D-TYPE LATCH WITH 3-STATE OUTPUTS

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#### **Electrical Characteristics**

over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER             | TEST CONDITIONS                                     | v <sub>cc</sub> | T <sub>A</sub> = 25°C |     |       | T <sub>A</sub> = −40°C<br>to 85°C |      | T <sub>A</sub> = −40°C<br>to 125°C |      | UNIT |
|-----------------------|---|-----------------|-----------------------|-----|-------|-----------------------------------|------|------------------------------------|------|------|
|                       |   |                 | MIN                   | TYP | MAX   | MIN                               | MAX  | MIN                                | MAX  |      |
| N/                    | I <sub>OH</sub> = -50 μA                            | 4.5 V           | 4.4                   | 4.5 |       | 4.4                               |      | 4.4                                |      | V    |
| V <sub>OH</sub>       | $I_{OH} = -16 \text{ mA}$                           | 4.5 V           | 3.8                   |     |       | 3.8                               |      | 3.8                                |      | v    |
| N/                    | I <sub>OL</sub> = 100 μA                            | 4.5 V           |                       | 0   | 0.1   |                                   | 0.1  |                                    | 0.1  | V    |
| V <sub>OL</sub>       | I <sub>OL</sub> = 16 mA                             | 4.5 V           |                       |     | 0.55  |                                   | 0.55 |                                    | 0.55 | v    |
| I <sub>I</sub>        | $V_{I} = 5.5 \text{ or GND}$                        | 0 to 5.5 V      |                       |     | ±0.1  |                                   | ±1   |                                    | ±1   | μA   |
| I <sub>OZ</sub>       | $V_{O} = V_{CC}$ or GND                             | 5.5 V           |                       |     | ±0.25 |                                   | ±2.5 |                                    | ±2.5 | μA   |
| I <sub>CC</sub>       | $V_{I} = V_{CC} \text{ or } GND, \qquad I_{O} = 0$  | 5.5 V           |                       |     | 2     |                                   | 20   |                                    | 20   | μA   |
| $\Delta I_{CC}^{(1)}$ | One input at 3.4 V, Other inputs at $V_{CC}$ or GND | 5.5 V           |                       |     | 40    |                                   | 50   |                                    | 50   | μA   |
| I <sub>off</sub>      | $V_{I}$ or $V_{O} = 0$ to 5.5 V                     | 0               |                       |     | 0.5   |                                   | 5    |                                    | 5    | μA   |
| Ci                    | $V_{I} = V_{CC} \text{ or } GND$                    |                 |                       | 4   | 10    |                                   | 10   |                                    | 10   | pF   |
| Co                    | $V_0 = V_{CC}$ or GND                               |                 |                       | 7.5 |       |                                   |      |                                    |      | pF   |

(1) This is the increase in supply current for each input at one of the specified TTL voltage levels, rather than 0 V or V<sub>CC</sub>.

#### **Timing Requirements**

over recommended operating free-air temperature range, V<sub>CC</sub> = 5 V  $\pm$  0.5 V (unless otherwise noted) (see Figure 1)

|                 |   |             | T <sub>A</sub> = 2 | $T_{A} = 25^{\circ}C \qquad \begin{array}{c} T_{A} = -40^{\circ}C \\ to 85^{\circ}C \end{array}$ |     | T <sub>A</sub> = -<br>to 12 | 40°C<br>5°C | UNIT |    |
|-----------------|---|-------------|--------------------|--|-----|-----------------------------|-------------|------|----|
|                 |   |             | MIN                | MAX  | MIN | MAX                         | MIN         | MAX  |    |
| tw              | Pulse duration, LE high                 | 6.5         |                    | 8.5  |     | 8.5                         |             | ns   |    |
| t <sub>su</sub> | Setup time, data before LE $\downarrow$ | High or low | 1.5                |  | 1.5 |                             | 1.5         |      | ns |
| t <sub>h</sub>  | Hold time, data after LE $\downarrow$   | High or low | 3.5                |  | 3.5 |                             | 3.5         |      | ns |

### **Switching Characteristics**

over recommended operating free-air temperature range,  $V_{CC}$  = 5 V ± 0.5 V (unless otherwise noted) (see Figure 1)

| PARAMETER          | FROM<br>(INPUT) | TO       | LOAD<br>CAPACITANCE    | Т,   | ע = 25° | с    | T <sub>A</sub> = -<br>to 8 |      | T <sub>A</sub> = -<br>to 12 | -40°C<br>25°C | UNIT |
|--------------------|-----------------|----------|------------------------|--|---------|------|----------------------------|------|-----------------------------|---------------|------|
|                    | (INPOT)         | (OUTPUT) | CAPACITANCE            | MIN         TYP         MAX         MIN         MAX         MIN         MAX         MIN         MAX           2.9         5.1         8.5         1         9.5         1         10           3.5         7.7         12.3         1         13.5         1         14           3.5         6.3         10.9         1         12.5         1         13           1.7         3.3         7.2         1         8.5         1         9 |         |      |                            |      |                             |               |      |
| +                  | D               | Q        |                        | 2.9  | 5.1     | 8.5  | 8.5 1                      | 9.5  | 1                           | 10            |      |
| t <sub>pd</sub>    | LE              | Q        | C = 15  pF             | 3.5  | 7.7     | 12.3 | 1                          | 13.5 | 1                           | 14            | ns   |
| t <sub>en</sub>    | OE              | Q        | C <sub>L</sub> = 15 pF | 3.5  | 6.3     | 10.9 | 1                          | 12.5 | 1                           | 13            |      |
| t <sub>dis</sub>   | OE              | Q        |                        | 1.7  | 3.3     | 7.2  | 1                          | 8.5  | 1                           | 9             |      |
| +                  | D               | Q        |                        | 4.4  | 5.9     | 9.5  | 1                          | 10.5 | 1                           | 11            |      |
| t <sub>pd</sub>    | LE              | Q        |                        | 4.8  | 8.5     | 13.3 | 1                          | 14.5 | 1                           | 15            |      |
| t <sub>en</sub>    | OE              | Q        | C <sub>L</sub> = 50 pF | 5  | 7.1     | 11.9 | 1                          | 13.5 | 1                           | 14            | ns   |
| t <sub>dis</sub>   | OE              | Q        |                        | 3  | 8.8     | 11.2 | 1                          | 12   | 1                           | 12.5          |      |
| t <sub>sk(o)</sub> |                 |          |                        |  |         |      |                            | 1    |                             | 1             |      |

# Noise Characteristics<sup>(1)</sup>

 $V_{CC}=5~V,~C_L=50~pF,~T_A=25^\circ C$ 

|                     | PARAMETER                                     | MIN  | TYP  | MAX  | UNIT |
|---------------------|---|------|------|------|------|
| V <sub>OL(P)</sub>  | Quiet output, maximum dynamic V <sub>OL</sub> |      | 0.8  | 1    | V    |
| V <sub>OL(V)</sub>  | Quiet output, minimum dynamic V <sub>OL</sub> |      | -0.6 | -0.8 | V    |
| V <sub>OH(V)</sub>  | Quiet output, minimum dynamic V <sub>OH</sub> |      | 2.9  |      | V    |
| V <sub>IH(D)I</sub> | High-level dymanic input voltage              | 2.31 |      |      | V    |
| V <sub>IL(D)</sub>  | Low-level dynamic input voltage               |      |      | 0.99 | V    |

(1) Characteristics are for surface-mount packages only.

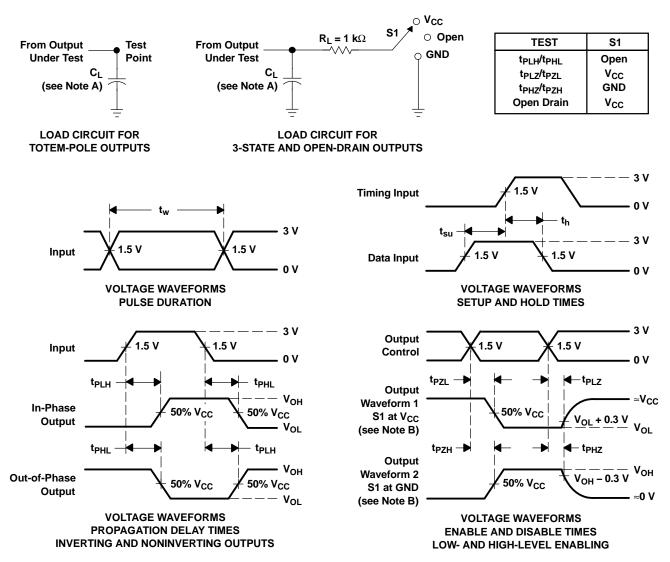
#### **Operating Characteristics**

 $V_{CC} = 5 \text{ V}, \text{ T}_{A} = 25^{\circ}\text{C}$ 

|                 | PARAME                        | TEST CO         | NDITIONS                | TYP        | UNIT |    |
|-----------------|-------------------------------|-----------------|-------------------------|------------|------|----|
| C <sub>pd</sub> | Power dissipation capacitance | Outputs enabled | C <sub>L</sub> = 50 pF, | f = 10 MHz | 15.5 | pF |

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#### PARAMETER MEASUREMENT INFORMATION



NOTES: A. C<sub>L</sub> includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  1 MHz, Z<sub>0</sub> = 50  $\Omega$ , t<sub>f</sub>  $\leq$  3 ns, t<sub>f</sub>  $\leq$  3 ns.
- D. The outputs are measured one at a time, with one input transition per measurement.
- E.  $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .
- F.  $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .
- G.  $t_{PHL}$  and  $t_{PLH}$  are the same as  $t_{pd}$ .
- H. All parameters and waveforms are not applicable to all devices.

#### Figure 1. Load Circuits and Voltage Waveforms



6-Feb-2020

### **PACKAGING INFORMATION**

| Orderable Device | Status | Package Type | •       | Pins | Package | Eco Plan                   | Lead/Ball Finish | MSL Peak Temp      | Op Temp (°C) | Device Marking | Samples |
|------------------|--------|--------------|---------|------|---------|----------------------------|------------------|--------------------|--------------|----------------|---------|
|                  | (1)    |              | Drawing |      | Qty     | (2)                        | (6)              | (3)                |              | (4/5)          |         |
| SN74LV373ATDWR   | ACTIVE | SOIC         | DW      | 20   | 2000    | Green (RoHS<br>& no Sb/Br) | NIPDAU           | Level-1-260C-UNLIM | -40 to 125   | LV373AT        | Samples |
| SN74LV373ATNSR   | ACTIVE | SO           | NS      | 20   | 2000    | Green (RoHS<br>& no Sb/Br) | NIPDAU           | Level-1-260C-UNLIM | -40 to 125   | 74LV373AT      | Samples |
| SN74LV373ATPWR   | ACTIVE | TSSOP        | PW      | 20   | 2000    | Green (RoHS<br>& no Sb/Br) | NIPDAU           | Level-1-260C-UNLIM | -40 to 125   | LV373AT        | Samples |

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

<sup>(4)</sup> There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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# PACKAGE MATERIALS INFORMATION

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#### TAPE AND REEL INFORMATION





### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



| *All dimensions are nominal |                 |                    |    |      |                          |                          |            |            |            |            |           |                  |
|-----------------------------|-----------------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| Device                      | Package<br>Type | Package<br>Drawing |    | SPQ  | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>W1 (mm) | A0<br>(mm) | B0<br>(mm) | K0<br>(mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
| SN74LV373ATDWR              | SOIC            | DW                 | 20 | 2000 | 330.0                    | 24.4                     | 10.8       | 13.3       | 2.7        | 12.0       | 24.0      | Q1               |
| SN74LV373ATNSR              | SO              | NS                 | 20 | 2000 | 330.0                    | 24.4                     | 8.4        | 13.0       | 2.5        | 12.0       | 24.0      | Q1               |
| SN74LV373ATPWR              | TSSOP           | PW                 | 20 | 2000 | 330.0                    | 16.4                     | 6.95       | 7.0        | 1.4        | 8.0        | 16.0      | Q1               |

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# PACKAGE MATERIALS INFORMATION

2-Oct-2019



\*All dimensions are nominal

| Device         | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|----------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74LV373ATDWR | SOIC         | DW              | 20   | 2000 | 367.0       | 367.0      | 45.0        |
| SN74LV373ATNSR | SO           | NS              | 20   | 2000 | 367.0       | 367.0      | 45.0        |
| SN74LV373ATPWR | TSSOP        | PW              | 20   | 2000 | 367.0       | 367.0      | 38.0        |

PW (R-PDSO-G20)

PLASTIC SMALL OUTLINE



NOTES:

A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.  $\beta$ . This drawing is subject to change without notice.

Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0,15 each side.

Body width does not include interlead flash. Interlead flash shall not exceed 0,25 each side.

E. Falls within JEDEC MO-153



# LAND PATTERN DATA



NOTES: Α. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
  C. Publication IPC-7351 is recommended for alternate design.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



# **DW0020A**



# **PACKAGE OUTLINE**

### SOIC - 2.65 mm max height

SOIC



NOTES:

- 1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M. 2. This drawing is subject to change without notice. 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.43 mm per side.
- 5. Reference JEDEC registration MS-013.



# DW0020A

# **EXAMPLE BOARD LAYOUT**

### SOIC - 2.65 mm max height

SOIC



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



# DW0020A

# **EXAMPLE STENCIL DESIGN**

### SOIC - 2.65 mm max height

SOIC



NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



### MECHANICAL DATA

#### PLASTIC SMALL-OUTLINE PACKAGE

#### 0,51 0,35 ⊕0,25⊛ 1,27 8 14 0,15 NOM 5,60 8,20 5,00 7,40 $\bigcirc$ Gage Plane ₽ 0,25 7 1 1,05 0,55 0-10 Δ 0,15 0,05 Seating Plane — 2,00 MAX 0,10PINS \*\* 14 16 20 24 DIM 10,50 10,50 12,90 15,30 A MAX A MIN 9,90 9,90 12,30 14,70 4040062/C 03/03

NOTES: A. All linear dimensions are in millimeters.

NS (R-PDSO-G\*\*)

**14-PINS SHOWN** 

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



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